

STGW60H65DRF

60 A, 650 V field stop trench gate IGBT with Ultrafast diode

Preliminary data

Features

- Very high speed switching
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance
- 6 µs short-circuit withstand time
- Ultrafast soft recovery antiparallel diode

Applications

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- High switching frequency converters

Description

This device is an IGBT developed using an advanced proprietary trench gate and field stop structure. This IGBT is the result of a compromise between conduction and switching losses, maximizing the efficiency of high switching frequency converters. Furthermore, a slightly positive $V_{CE(sat)}$ temperature coefficient and very tight parameter distribution result in easier paralleling operation.

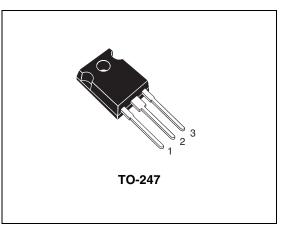


Figure 1. Internal schematic diagram

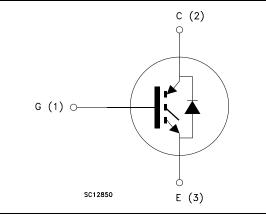


Table 1. Device summary

Order code Marking		Package	Packaging
STGW60H65DRF GW60H65DRF		TO-247	Tube

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Doc ID 022346 Rev 1

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

1

Electrical ratings

Table 2.	Absolute maximum ratings		
Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	650	V
Ι _C	Continuous collector current at $T_C = 25$ °C	120	А
Ι _C	Continuous collector current at $T_C = 100 \ ^{\circ}C$	60	А
$I_{CP}^{(1)}$	Pulsed collector current	180	А
V_{GE}	Gate-emitter voltage	±20	V
۱ _F	Diode RMS forward current at $T_C = 25 \text{ °C}$	40	А
I _{FSM}	Surge not repetitive forward current $t_p = 10 \text{ ms}$ sinusoidal	180	А
P _{TOT}	Total dissipation at $T_{C} = 25 \ ^{\circ}C$	360	W
t _{SC}	Short-circuit withstand time at V _{CC} = 400 V, V _{GE} = 15 V	6	μs
T _{STG}	Storage temperature range	- 55 to 150	
TJ	Operating junction temperature	- 33 10 130	°C

Table 2. Absolute maximum ratings

1. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case IGBT	0.35	°C/W
R _{thJC}	Thermal resistance junction-case diode	0.7	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W



2 Electrical characteristics

 T_J = 25 °C unless otherwise specified.

Table 4.	Static					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 2 mA	650			V
	V _{CE(sat)} Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 60 A		1.9		
V _{CE(sat)}		V _{GE} = 15 V, I _C = 60 A T _J = 125 °C		2.1		V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$		6.0		V
I _{CES}	Collector cut-off current $(V_{GE} = 0)$	V _{CE} = 650 V			25	μA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			250	nA

Table 4. Static

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V}, \text{ f} = 1 \text{ MHz},$ $V_{GE} = 0$	-	7150 275 140	-	pF pF pF
Qg	Total gate charge		-	217	-	nC
Q _{ge}	Gate-emitter charge	V _{CC} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	67	-	nC
Q _{gc}	Gate-collector charge		-	97	-	nC

Table 6.Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CE} = 400 V, I _C = 60 A, R _G = 10 Ω, V _{GE} = 15 V	-	85 33 1800	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CE} = 400 \text{ V}, I_C = 60 \text{ A},$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_J = 125 \text{ °C}$	-	82 35 1680	-	ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	-	34 178 30	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_C = 60 \text{ A},$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_J = 125 \text{ °C}$	-	45 205 70	-	ns ns ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	-	0.94 1.06 2.0	-	mJ mJ mJ
Eon ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CE} = 400 \text{ V}, I_C = 60 \text{ A},$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_J = 125 \text{ °C}$	-	1.15 1.4 2.55	-	mJ mJ mJ

 Table 7.
 Switching energy (inductive load)

 Eon is the turn-on losses when a typical diode is used in the test circuit in *Figure 2*. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C).

2. Turn-off losses include also the tail of the collector current.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 30 A I _F = 30 A, T _J = 125 °C	-	2.6 1.45	-	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 60 A, V _R = 400 V, di/dt = 1700 A/μs	-	19 200 15.5	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 60 A, V _R = 400 V, di/dt = 1630 A/µs T _J = 125 °C	-	34 780 46	-	ns nC A



3 Test circuits

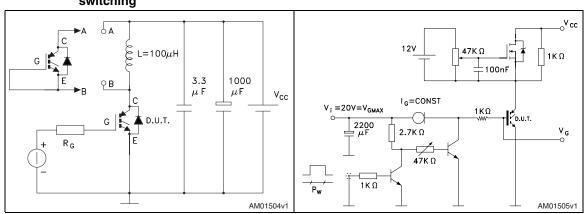


Figure 3.

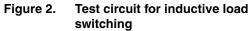
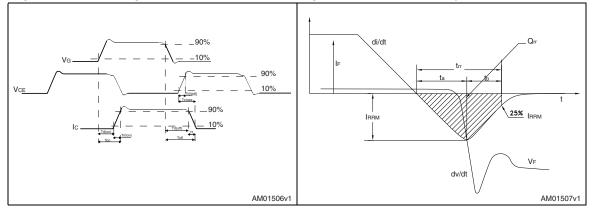


Figure 4. Switching waveform



Gate charge test circuit





4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Dim.		mm.	
	Min.	Тур.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
с	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Table 9. TO-247 mechanical data





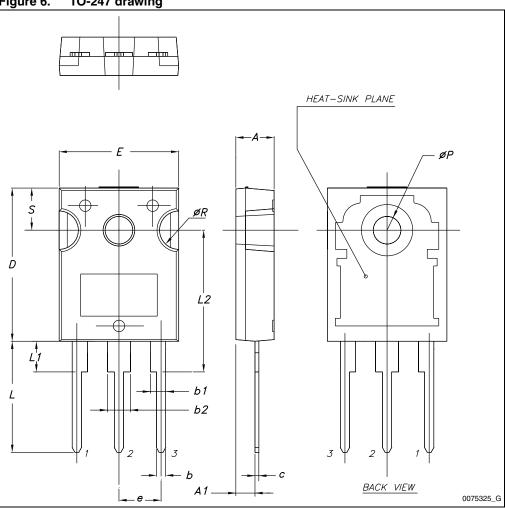


Figure 6. TO-247 drawing



5 Revision history

Table 10. Document revision history

Date	Revision	Changes
11-Oct-2011	1	Initial release.



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